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Processing and dielectric characterization of Ba_{0.3}Sr_{0.7}TiO₃ thin films on alumina substrates

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Abstract

Ba_{0.3}Sr_{0.7}TiO₃ (BST) thin films were prepared from the sols based on alkaline earth acetates and titanium propoxide in 2-methoxyethanol–acetic acid solvents and deposited on polished alumina substrates by spin coating. The perovskite phase crystallizes upon heating at/above 700 °C. By increasing the annealing temperature from 700 to 900 °C the grain size increases from 40 to 80 nm, due to the increased driving force for crystallization. The annealing time has got only a minor influence on grain size as a consequence of constrained conditions of the film. The dielectric permittivity and tunability ($\varepsilon_0 v/\varepsilon_{200 v}$) of BST films, measured at 1 MHz, strongly depend on the grain size, exhibiting the values of 345 and 1.47, and 722 and 1.93 for the films with 40 and 80 nm-sized grains, respectively.

Keywords: Films; Grain size; Dielectric properties; Functional applications; (Ba,Sr)TiO₃

1. Introduction

Ferroelectric thin films have been intensively studied for possible applications in tunable microwave devices because of their high dielectric permittivity, low dielectric losses and high tunability, that is the non-linear dependence of the permittivity on the applied electric field. Ferroelectric domains lead to high dielectric losses, therefore materials for tunable applications are generally used in the paraelectric state, where the losses are low, while the permittivity is still large.

(Ba,Sr)TiO₃ solid solution is among the most promising candidates for tunable devices. Its Curie temperature strongly depends upon the Ba/Sr ratio³ and the compositions, which are in the paraelectric phase at room temperature, exhibit high permittivity and low losses at microwave frequencies.²

Thin film microstructure critically influences the dielectric properties. For films, prepared by chemical solution deposition (CSD) the microstructure can be tailored by the chemistry of the sol and by the processing conditions, mainly by the temperatures of the individual heat treatment steps—drying,

pyrolysis and annealing. Hoffmann and Waser showed that in BaTiO₃ and SrTiO₃ thin films on platinized silicon substrates, the microstructure can be tailored from granular to columnar by adjusting the sol concentration and heating regime. The columnar BaTiO₃ films annealed at 750 °C exhibit higher permittivity than the granular films.⁴ Kageyama et al. observed that the grain size of Ba_{0.6}Sr_{0.4}TiO₃ films on sapphire increases with increasing film thickness in the range 90-1050 nm; the permittivity is almost constant and the tunability increases with the film thickness.⁵ Ihlefeld et al. prepared BaTiO₃ films on Cu foils. They found that with increasing annealing temperature and consequently increasing the grain size, the permittivity of the films increases, reaching the values close to those of bulk material.⁶ A similar relationship between annealing temperature, the microstructure and the dielectric properties has been reported for (Ba,Sr)TiO₃ thin films on platinized silicon⁷ and platinized alumina substrates, 8 namely with increasing the annealing temperature the grain size increases and the dielectric properties are improved.

The aim of the present work was to prepare Ba_{0.3}Sr_{0.7}TiO₃ (BST) thin film capacitors on alumina substrates and to study the effect of the annealing conditions on the microstructure development and consequently on the dielectric properties. The composition with Ba/Sr ratio of 30/70 with the Curie temper-

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ature of about $-100\,^{\circ}\text{C}$, was selected because it is suitable for electrical beam steering in a wide temperature range, for example on-board mobile platforms such as airplanes.

2. Experimental

 $Ba_{0.3}Sr_{0.7}TiO_3$ thin films were deposited on polished alumina substrates (99.6%, 25.4 mm \times 25.4 mm \times 0.26 mm or 10 mm \times 10 mm \times 0.26 mm, Coorstek). The BST sols were prepared from alkaline earth acetates ($Ba(CH_3COO)_2$, 99.0–102.0%, $Sr(CH_3COO)_2 \times 0.5 \cdot H_2O$, reagent grade, JM Alfa) and Ti propoxide ($Ti(OC_3H_7)_4$, JM Alfa). The acetates were dried before use. Metal content of the starting compounds was determined gravimetrically. Ti-propoxide was diluted by 2-methoxyethanol (99.3%, Aldrich) and the acetates were dissolved in acetic acid (100%, JM Alfa). The two solutions were mixed for 2 h at 60 °C. The concentration of the sol was adjusted to 0.25 or 0.4 M.

The films were prepared by two-step annealing, where the first step was to deposit the 0.25 M sol on the alumina substrate, dry at 200 °C for 2 min, pyrolyze at 350 °C for 2 min and anneal at 700 °C for 15 min in air. In the next step, the 0.4 M sol was deposited on the substrate, dried at 200 °C for 2 min and pyrolyzed at 350 °C for 2 min. The procedure was repeated five times. The film was then annealed at 700–900 °C for 15–60 min in air. In all cases the samples were quickly pushed into the heated tube-furnace. The final film thickness measured by Rank Taylor Hobson profilometer was between 300 and 400 nm.

The phase composition of the thin films was determined by X-ray diffraction (XRD) using a Cu K α radiation source in a θ -2 θ geometry. The microstructure was analyzed by field emission scanning electron microscopy (FE-SEM, Supra 35 VP, Carl Zeiss). The grain size was calculated by the lineal intercept method by counting 100–150 grains.

For dielectric measurements, air-gapped capacitors (0.750 mm \times 1.5 mm) were patterned by lift-off photolithography and Cr/Au electrodes were deposited by magnetron sputtering. The gap width for the BST capacitors was $8.5 \pm 1 \,\mu m$.

The room temperature low-frequency dielectric measurements were performed with a computer controlled measurement set-up consisting of a Keithley 237 Source Measure Unit and a HP 4192A Impedance Analyzer. Capacitance–voltage characteristics were recorded using the following dc voltage cycle: $0 \text{ V} \rightarrow +200 \text{ V} \rightarrow 0 \text{ V} \rightarrow -200 \text{ V} \rightarrow 0 \text{ V}$.

3. Results

BST thin films on alumina crystallize in randomly oriented perovskite phase after annealing at 700 °C. By increasing the annealing temperature to 900 °C, we observe that the width of the perovskite peaks (FWHM) decreases and that the relative intensity of the peaks increases indicating improved crystallinity (Fig. 1).

The SEM micrograph of the fracture surface of the film annealed at 700 °C for 60 min reveals 40 nm sized equiaxed grains (Fig. 2). Similar granular cross-section microstructure

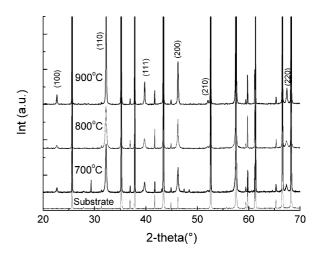


Fig. 1. XRD patterns of $Ba_{0.3}Sr_{0.7}TiO_3$ thin films on alumina annealed at 700–900 °C for 60 min. The main reflections of the perovskite phase are indexed. The XRD pattern of the alumina substrate is added for reference.

was observed in all investigated BST films. The granular microstructure is in agreement with the mechanism of nucleation of the perovskite phase within the bulk of the film proposed by Hoffmann and Waser for BaTiO₃ and (Ba,Sr)TiO₃ thin films on Pt/Si substrates.⁴ Granular microstructure was also observed for (Ba,Sr)TiO₃ thin films grown on platinized alumina,⁸ Pt/Si^{4,9} and sapphire.⁵

In order to obtain insight into the influence of annealing conditions on the microstructure development of BST thin films we compared surface microstructures of the films annealed at 700 and 900 °C (Fig. 3). The films annealed at 700 °C for 15 and 60 min consist of about 40–45 nm sized grains, respectively. The grain size remains almost the same after increasing the annealing time even to 300 min (micrograph not shown here).

By increasing the annealing temperature to $900\,^{\circ}\text{C}$ the microstructure noticeably coarsens. The average grain size in the BST films, annealed for 15 and 60 min, is 60 and 80 nm, respectively. There is some interganular porosity in all analyzed samples, but it is difficult to quantify its content.

We explain the strongly promoted grain growth with the increased annealing temperature by the mechanism of thin film crystallization. When the amorphous film with some remaining

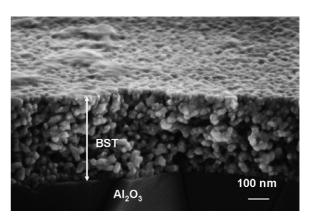


Fig. 2. FE-SEM micrograph of the fracture surface of $Ba_{0.3}Sr_{0.7}TiO_3$ film on alumina prepared by two-step annealing at 700 °C for 60 min.

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